



N-Channel 30-V (D-S) MOSFET with Schottky Diode

MOSFET PRODUCT SUMMARY					
$V_{DS}(V)$ $R_{DS(on)}(\Omega)$ I_{I}					
30	0.016 at $V_{GS} = 10 \text{ V}$	9.5			
	0.021 at V _{GS} = 4.5 V	7.7			

SCHOTTKY PRODUCT SUMMARY					
V _{DS} (V)	V _{SD} (V) Diode Forward Voltage	I _F (A)			
30	0.50 V at 1.0 A	1.4			

		SO-8		
S	1		8	D
S	2		7	D
S	3		6	D
G	4		5	D
			l	

Top View

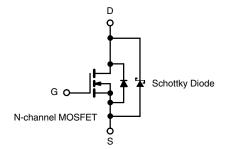
Ordering Information: Si4812BDY-T1-E3 (Lead (Pb)-free)

Si4812BDY-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- Halogen-free According to IEC 61249-2-21 Available
- LITTLE FOOT® Plus Power MOSFET
- 100 % R_g Tested





ABSOLUTE MAXIMUM RATINGS	A = 25 °C, unle	ss otherwise	noted			
Parameter			Limit			
		Symbol	10 s	Steady State	Unit	
Drain-Source Voltage (MOSFET)		V _{DS}	30			
Reverse Voltage (Schottky)		V DS	30		V	
Gate-Source Voltage (MOSFET)		V _{GS}	± 20			
Continuous Drain Current (T _J = 150 °C) (MOSFET	$T_{A} = 25 ^{\circ}C$ $T_{A} = 70 ^{\circ}C$	I _D	9.5	7.3		
Continuous Drain Current (1) = 150 °C) (MOSFET	T _A = 70 °C	טי	7.7	5.9	İ	
Pulsed Drain Current (MOSFET)	I _{DM}	50				
Continuous Source Current (MOSFET Diode Conde	I _S	2.1	1.2	Α		
Average Forward Current (Schottky)		I _F	1.4	0.8		
Pulsed Forward Current (Schottky)		I _{FM}	30			
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	5 1.25			
Avalanche Energy	L = 0.1 IIII1	E _{AS}			mJ	
Maximum Power Dissipation (MOSFET) ^{a, b}	T _A = 25 °C		2.5	1.4	W	
Maximum Power Dissipation (MOSFET)***	T _A = 70 °C	P _D	1.6	0.9		
Maximum Power Dissipation (Schottky) ^{a, b}	T _A = 25 °C	υ .	2.0	1.2		
waximum Power Dissipation (Schottky)	T _A = 70 °C		1.3	0.8		
Operating Junction and Storage Temperature Rang	е	T _J , T _{stg}	- 55	5 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter	Device	Symbol	Typical	Maximum	Unit	
Mariana landia la Ambient (L. 40 a)	MOSFET	R _{thJA}	40	50		
Maximum Junction-to-Ambient (t ≤ 10 s) ^a	Schottky		50	60		
Maximum landing to Application (A. Olanda Olata)	MOSFET		72	90	°C/W	
Maximum Junction-to-Ambient (t = Steady State) ^a	Schottky		85	100	- C/W	
Mariana landia la Frat (L. Olarda Olata)	MOSFET	D	18	23		
Maximum Junction-to-Foot (t = Steady State) ^a	Schottky	R _{thJF}	24	30	1	

Notes:

a. Surface Mounted on FR4 board.

 $b.\ t \leq 10\ s.$

Si4812BDY

Vishay Siliconix



MOSFET AND SCHOTTKY SPECIFICATIONS $T_J = 25$ °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1		3	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$		0.004	0.100	mA	
Zero Gate Voltage Drain Current (MOSFET and Schottky)	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V, T _J = 100 °C		0.7	10		
(MOSI ET and Solicitity)		V _{DS} = 30 V, V _{GS} = 0 V, T _J = 125 °C		3.0	20		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	20			Α	
	В	V _{GS} = 10 V, I _D = 9.5 A		0.013	0.016	0	
Drain-Source On-State Resistance ^a	R _{DS(on)} —	$V_{GS} = 4.5 \text{ V}, I_D = 7.7 \text{ A}$		0.0165	0.021	Ω	
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 15 \text{ V}, I_D = 9.5 \text{ A}$		45		S	
	V	I _S = 1.0 A, V _{GS} = 0 V		0.45	0.50	V	
Schottky Diode Forward Voltage ^a	V _{SD} _	I _S = 1.0 A, V _{GS} = 0 V, T _J = 125 °C		0.33	0.42	V	
Dynamic ^b							
Total Gate Charge	Q_g			8.5	13		
Gate-Source Charge	Q_{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 5 \text{ V}, I_D = 9.5 \text{ A}$		3		nC	
Gate-Drain Charge	Q_{gd}			2.6			
Gate Resistance	R_g		0.3	0.7	1.1	Ω	
Turn-On Delay Time	t _{d(on)}			15	25		
Rise Time	t _r	V_{DD} = 15 V, R_L = 15 Ω		13	20		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 6 \Omega$		20	30	ns	
Fall Time	t _f			8	15		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 1.0 A, dI/dt = 100 A/μs		22	35		

Notes:

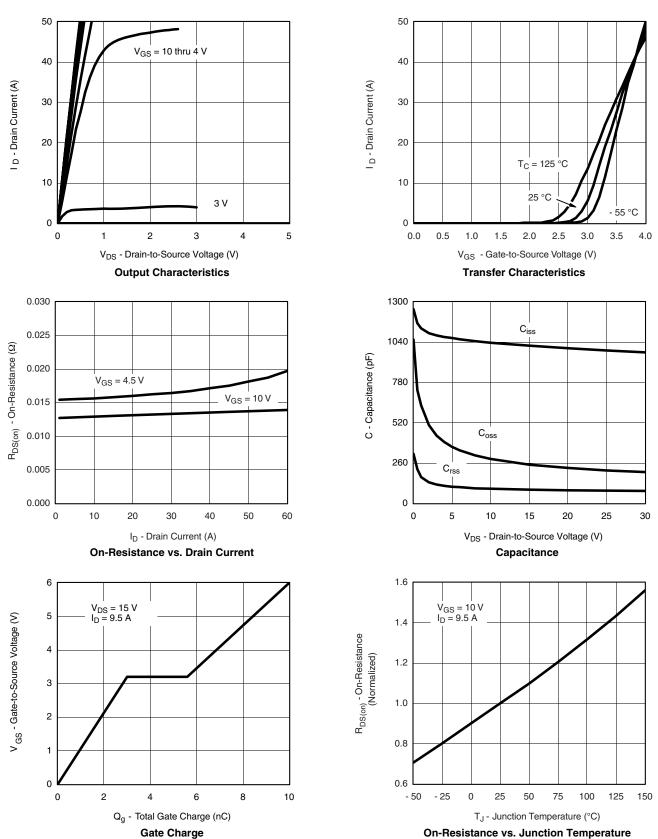
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$

b. Guaranteed by design, not subject to production testing.



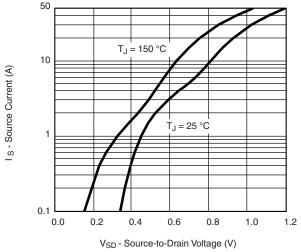
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



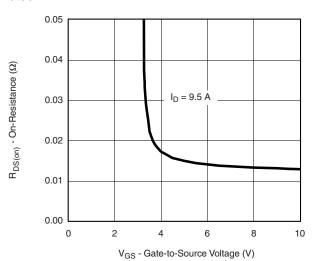
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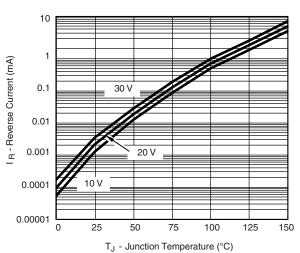
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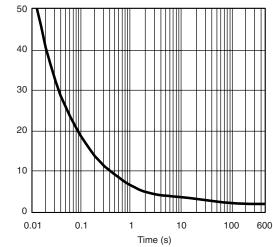




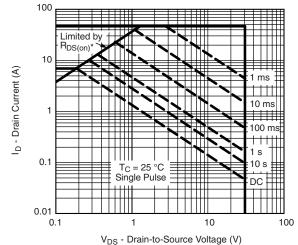
On-Resistance vs. Gate-to-Source Voltage



Reverse Current (Schottky)



Single Pulse Power (MOSFET)



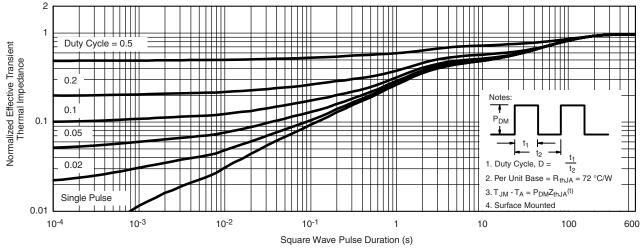
Power (W)

* V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified

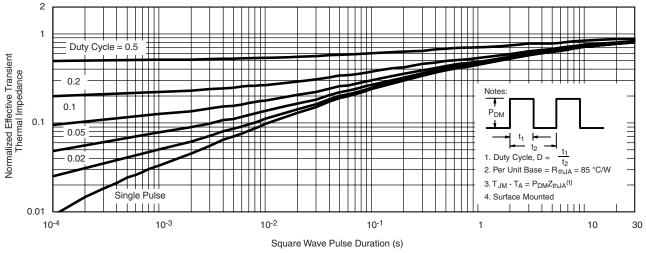
Safe Operating Area, Junction-to-Case



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient (MOSFET)



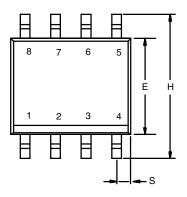
Normalized Thermal Transient Impedance, Junction-to-Ambient (Schottky)

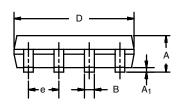
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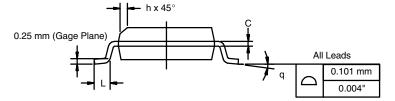
Document Number: 73038 www.vis S-83039-Rev. D, 29-Dec-08



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INCHES		
DIM	Min	Max	Min	Max	
Α	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
Е	3.80	4.00	0.150	0.157	
е	1.27 BSC		0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I. 11-Sep-06					

DWG: 5498

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APPLICATION NOTE



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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